167892-6 × OBSOLETE

AMP POWER TAP

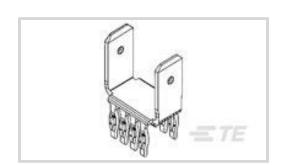
TE Internal #: 167892-6

TE Internal Description: 8P.P.L.TERM.(H)

View on TE.com >



Terminals & Splices > Power Terminals



Power Terminal Type: Power Tap

Product Terminates To: Printed Circuit Board

Number of Positions: 8

Contact Current Rating (Max): 40 A
Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

Froduct Type Features	
Power Terminal Type	Power Tap
Configuration Features	
Number of Positions	8
PCB Mount Orientation	Vertical
Body Features	
Terminal Profile	Standard
Contact Features	
Mating Tab Thickness	.8 mm[.032 in]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Mating Area Plating Material Finish	Bright
Mating Tab Width	6.35 mm[.25 in]
Contact Current Rating (Max)	40 A
Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material	Tin (Sn)

5 μm[196.85 μin]

5 μm[196.85 μin]

Phosphor Bronze

Tin

Termination Features

Contact Base Material

Contact Mating Area Plating Material Thickness

PCB Contact Termination Area Plating Material

PCB Contact Termination Area Plating Material Thickness



Termination Method to PCB	Through Hole - Press-Fit
Product Terminates To	Printed Circuit Board
Mechanical Attachment	
Mating Retention Type	Hole
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
PCB Thickness (Recommended)	3.18 mm[.125 in]
Product Length	13 mm[.511 in]
Usage Conditions	
Insulation Option	Uninsulated
Packaging Features	
Packaging Method	Box

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on



requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Customers Also Bought



















Documents

Product Drawings 8P.P.L.TERM.(H)

English

CAD Files

Customer View Model

ENG_CVM_CVM_167892-6_F.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_167892-6_F.3d_igs.zip

English

Customer View Model



ENG_CVM_CVM_167892-6_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

POWER_CONNECTORS_CATALOG_SEC02_CABLE_MOUNTED

English

PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English